<u>ΡΑ ΓΈΝΤ</u>

REMARKS/ARGUMENTS

This Amendment is responsive to the Office Action mailed on September 15, 2004. In this Amendment, claims 7, 16, 17, and 22 are amended, and claim 26 is added, o that claims 7-26 are pending and subject to examination.

Claims 7-17 are rejected for statutory double patenting. Applicants subm: that claims 7-17 are not the same as claims 7-17 in co-pending application no. 10/702,792, si ce the claims in 10/702,792 were amended by a preliminary amendment. Moreover, in this Amendment, independent claim 7 is amended. The claims in 10/702,792 and the claims n this application are thus not the same. Accordingly, withdrawal of the double patenting rejection is requested.

A number of prior art rejections are made. The prior art rejections are addressed in the order presented in the Office Action.

I. McShane et al.

Claims 7, 8, 14, 18, 20, and 24 are rejected as anticipated by McShane et .1. (US Patent No. 5,147,821). According to the Office Action, McShane et al. teaches "providir g a die 12 that includes a metallized backside 14". This rejection is traversed.

A. Independent claim 7

McShane et al. does not anticipate independent claim 7, since each and every claim element is not taught or suggested by McShane et al. "A claim is anticipated only f each and every element as set forth in the claim is found, either expressly or inherently descril ed, in a single prior art reference." *Verdegaal Bros. v. Union Oil Co. of California*, 814 F.2d 621, 631, 2 USPQ2d 1051, 1053 (Fed. Cir. 1987). Claim 7 recites a method comprising, *inter alia*, "providing a die that includes a backside, wherein the backside of the die forms an electrical

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terminal." FIG. 1 of McShane et al. shows a semiconductor die 12. The backside of the ie 12 is mounted on a mounting surface 14 of a leadframe 16. The backside of the semiconducto die 12 in McShane et al. clearly does not form an electrical terminal. For example, element 24 i 1 FIG. 1 of McShane is a heat sink and does not provide any electrical function. Accordingly, \(\lambda\) cShane et al. fails to anticipate independent claim 7.

It would also not have been obvious to have modified McShane et al. to at ive at the invention defined by independent claim 7. Obviousness can only be established by combining or modifying the teachings of the prior art to produce the claimed invention where there is some teaching, suggestion, or motivation to do so. In re Fine, 837 F.2d 1071, 51 SPQ2d 1596 (Fed. Cir. 1988). Here, there is no motivation to modify McShane et al.'s package to that the backside of the die 12 has an electrical terminal. As shown in FIGS. I and 2 of McSl and et al., the backside of the die 12 is connected to the heat sink 24. One could not provide an electrical connection to the heat sink 24, since the electrical connections to the package 1 are made on the opposite side of the package 10 via the leads 18 and 18. Accordingly, McS and et al. fails to anticipate or obviate claim 7 or any dependent claims thereon.

B. Independent claim 18

McShane et al. fails to teach or suggest a method comprising, inter alia, "encapsulating [a] semiconductor die and at least a portion of the leadframe with a molding compound having a window and an exterior surface, wherein the backside of the semicon ductor die is exposed through the window of the molding compound and wherein the backside is substantially flush with the exterior surface of the molding compound" as recited in index and claim 18. With regard to claim 18, the Office Action states that the "thickness 52 is heur stic and may be quite thin in addition to 'substantially flush' being subjective to the observer, col. 7, line 35 - col. 8, line 10."

Applicants have reviewed col. 7, line 35 to col. 8, line 10 of McShane et ε and it does not support the Examiner's allegation that the thickness 52, which is a heat sink, is "heuristic" and/or that the phrase "substantially flush" is subjective. Should the Examine

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maintain this position, the Examiner is requested to point out where the term "heuristic" i . at col. 7, line 35 to col. 8, line 10.

Moreover, as noted above, "52" in FIG. 4 of McShane et al. is a "heat sink ' and is not the backside of the die 12. The rejection as to claim 18 and dependents thereon shou 1 be withdrawn for this reason alone.

FIG. 1 of McShane et al. clearly shows that the exterior surface of the pac age body 22 is clearly not "substantially flush" with any surface of the die 12, let alone the backside of the die 12. In fact, the backside of the die 12 cannot be "substantially flush" with the acterior of the body 22, or else the body 22 would not be able to attach to the heat sink 24 illustrated in FIG. 1. Accordingly, the allegation that FIG. 1 of McShane et al. shows the surface of the die 12 being "substantially flush" with the exterior surface of the body 22 would be based on an unreasonable interpretation of the phrase "substantially flush" and an unreasonable reading of McShane et al. Put another way, to the extent that the Examiner believes that one may "subjectively" interpret the phrase "substantially flush" to read on McShane et al., Applicants submit that such an interpretation would be unreasonable. During patent examination, the claims are given their broadest reasonable interpretation consistent with the specification. In re Hyatt, 211 F.3d 1367, 1372, 54 USPQ2d 1664, 1667 (Fed. Cir. 2000). Again, Applicants submit that the Examiner's interpretation of the claims is "unreasonable", and not reasonable.

It would also not have been obvious to have modified McShane et al. to h ve arrived at the invention defined by independent claim 18. If a proposed modification we all render the prior art invention being modified unsatisfactory for its intended purpose, there there is no suggestion or motivation to make the proposed modification. In re Gordon, 733 F.2d 300, 221 USPQ 1125 (Fed. Cir. 1984). Here, if one were to modify McShane et al. to have a ie backside that is substantially flush with the exterior surface of the molding compound, or e would have to remove the heat sink 24. The heat sink 24 is a critical part of McShane et al.'s invention. See column 2, lines 58-62 of McShane et al. Accordingly, there is no motiva ion to modify McShane et al. to arrive at the invention of claim 18 and McShane et al. does not render claim 18 or any claims dependent claims thereon obvious.

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II. McShane et al. and Maejima et al.

Claim 9 is rejected as obvious over McShane et al. and Maejima et al. (U: 5,347,709). This rejection is traversed.

Maejima et al. is cited for its alleged teaching of "resin flashing". Applicants submit that Maejima et al. does not remedy the above-noted deficiencies of independent laim 7.

III. McShane et al. and Orso et al.

Claims 10-12 are rejected as obvious over McShane and Orso et al. (U.S. 'atent No. 6,018,686). This rejection is traversed.

Orso et al. is cited for its alleged teaching of marking a boy on the surface opposite the window. Applicants submit that Maejima et al. does not remedy the above-oted deficiencies of independent claim 7.

IV. McShane et al. and Layber

Claims 13, 15, and 23 are rejected as obvious over McShane et al. and La her (U.S. Patent No. 4,678,358). This rejection is traversed.

Layer does not remedy the above-noted deficiencies of independent claims 7 and 18.

V. McShane et al. and Fosberry et al.

Claims 16, 17, and 21 are rejected as obvious over McShane and Fosberre et al. (U.S. Patent No. 6,214,640). This rejection is traversed.

Fosberry et al. is cited for its alleged teaching of posts for attaching dies. Applicants submit that Fosberry et al. does not remedy the above-noted deficiencies of independent claims 7 and 18.

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VI. McShane et al. and Merrill

Claims 19 and 22 are rejected as obvious over McShane et al. in view of 1 lerrill (U.S. 5,654,206). Merrill is alleged to teach transistors. Applicants submit that Merrill coes not remedy the above-noted deficiencies of McShane et al.

CONCLUSION

For the reasons provided above, Applicants submit that the claims are all wable. If the Examiner believes a telephone conference would expedite prosecution of this application, please telephone the undersigned at 415-576-0200.

Respectfully submitted,

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